



Product Change Notification

Change Notification #: 116297 - 00
Change Title: Intel® Server Board S2600BPB,
Intel® Server Board S2600BPQ,
Intel® Server Board S2600BPS,
PCN 116297-00, Product Design,
Updated BIOS/ME/BMC/FRUSDR
Firmware
Date of Publication: June 11, 2018

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	June 25, 2018
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following changes on the Intel® Compute Module products listed in the Products affected table below:

1. Update of the System Firmware installed at the Factory.
2. Update the BIOS from revision R00.01.0009 to revision R00.01.5013.
3. Update the Manageability Engine (ME) firmware from revision 04.00.04.288 to revision 04.00.04.294.
4. Update the Integrated Baseboard Management Controller (BMC) firmware from revision 01.29.7d703f59 to revision 1.43.660a4315.
5. Update the FRUSDR from revision 1.24 to revision 1.30.
6. Update the NIC EEPROM revision 0.46.

“WARNING: This Server is running factory firmware. A software update is required. As part of your system integration process, please load the latest system update package (SUP) to enable the latest security, quality and performance.”

Customer Impact of Change and Recommended Action:

The primary value of this factory BIOS is that it allows the customer to perform a single BIOS programming (upgrade or downgrade) without the requirement of moving the BIOS Recovery physical jumper. Once the first programming is done, any subsequent attempts to downgrade to a previous BIOS version will require moving the BIOS Recovery physical jumper.

Intel does not expect any other impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
BBS2600BPB	948899	J13485-552	J13485-553
BBS2600BPQ	948900	J13486-552	J13486-553
BBS2600BPS	952609	J39290-352	J39290-353

PCN Revision History:

Date of Revision:

June 11, 2018

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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